# IRLD110

Vishay Siliconix



**HVMDIP** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>qs</sub> (nC)

Q<sub>ad</sub> (nC)

Qg (Max.) (nC)

Configuration

# **Power MOSFET**

s

N-Channel MOSFET

0.54

100

6.1

2.6

3.3

Single

 $V_{GS} = 5 V$ 

## FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- · For automatic insertion
- End stackable
- Logic-level gate drive
- $R_{DS(on)}$  specified at  $V_{GS} = 4 V$  and 5 V
- 175 °C operating temperature
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRLD110PbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	100	- V	
Gate-source voltage			V <sub>GS</sub>	± 10		
Continuous drain current	$T_A = 25 \text{°C}$			1		
Continuous drain current	$V_{GS}$ at 5 V	T <sub>A</sub> = 100 °C	I <sub>D</sub>	0.70	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	8		
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	100	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	1	Α	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	0.13	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$		PD	1.3	W		
Peak diode recovery dv/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	
Soldering rRecommendations (peak temperature) d For 10 s			300 <sup>d</sup>			

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 6.4 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.6 A (see fig. 12)

c.  $I_{SD} \le 5.6$  A, dl/dt  $\le 75$  A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C

d. 1.6 mm from case

S21-0886-Rev. E, 30-Aug-2021

1 For technical questions, contact: <u>hvm@vishay.com</u> RoHS COMPLIANT



THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μΑ	100	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	: V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	1	-	2	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 10 \text{ V}$		-	-	± 100	nA
Zana Cata Maltana Duain Current		V <sub>DS</sub> =	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V		-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	-	250	μA
	_	$V_{GS} = 5 V$	I <sub>D</sub> = 0.60 A <sup>b</sup>	-	-	0.54	Ω
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 4 V$	I <sub>D</sub> = 0.50 A <sup>b</sup>	-	-	0.76	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	50 V, I <sub>D</sub> = 0.60 A <sup>b</sup>	1.3	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V,		-	250	-	
Output Capacitance	C <sub>oss</sub>			-	80	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	6.1	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5 V	$I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	2.6	nC
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 0 and 15	-	-	3.3	
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.3	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, \text{ I}_D = 5.6 \text{ A},$ $\text{R}_g = 12 \ \Omega, \ \text{R}_D = 8.4 \ \Omega, \ \text{see fig. } 10^{\text{b}}$		-	4.7	-	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	16	-	
Fall Time	t <sub>f</sub>			-	17	-	
Internal Drain Inductance	L <sub>D</sub>	6 mm (0.25")	Between lead, 6 mm (0.25") from		4	-	
Internal Source Inductance	L <sub>S</sub>	package and center of die contact		-	6	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	1	Α
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	8	] ^	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 1 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	тосесь		-	110	130	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$I_{\rm J} = 25 {}^{\circ}{\rm C}, I_{\rm F}$	= 5.6 A, dl/dt = 100 A/µs <sup>b</sup>	-	0.50	0.65	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

Notes

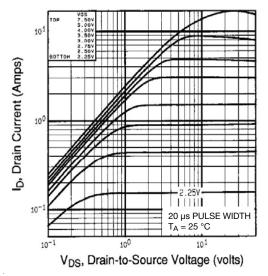
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

2



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





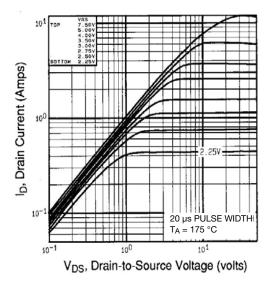


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 175 °C

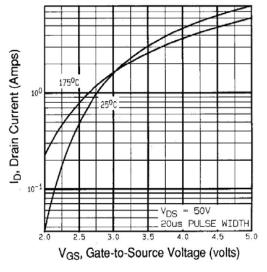


Fig. 2 - Typical Transfer Characteristics

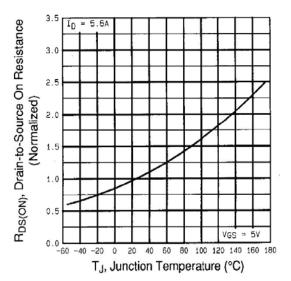


Fig. 3 - Normalized On-Resistance vs. Temperature



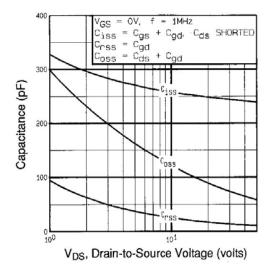


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

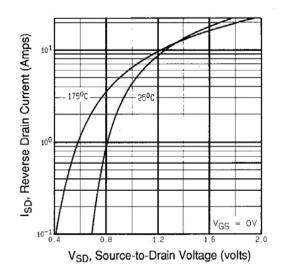


Fig. 6 - Typical Source-Drain Diode Forward Voltage

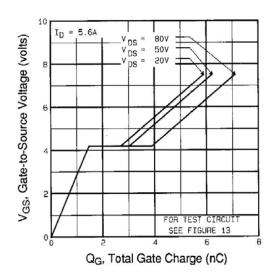


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

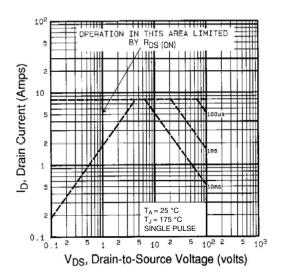


Fig. 7 - Maximum Safe Operating Area



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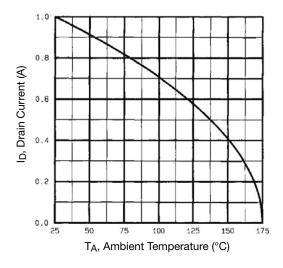


Fig. 8 - Maximum Drain Current vs. Ambient Temperature

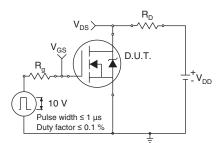


Fig. 9 - Switching Time Test Circuit

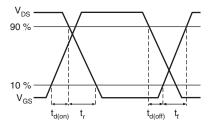


Fig. 10 - Switching Time Waveforms

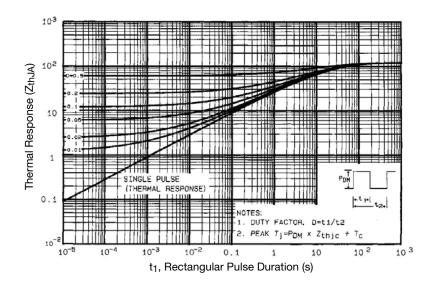


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



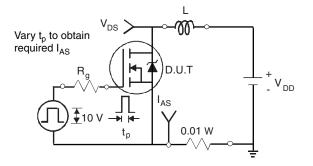


Fig. 12 - Unclamped Inductive Test Circuit

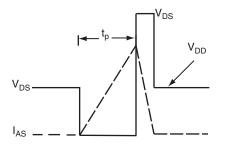


Fig. 13 - Unclamped Inductive Waveforms

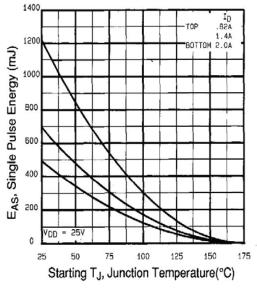
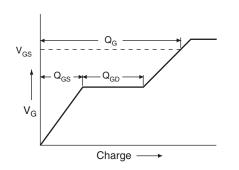


Fig. 14 - Maximum Avalanche Energy vs. Drain Current





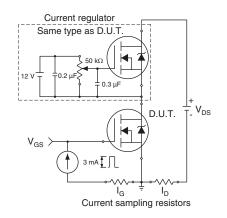


Fig. 16 - Gate Charge Test Circuit

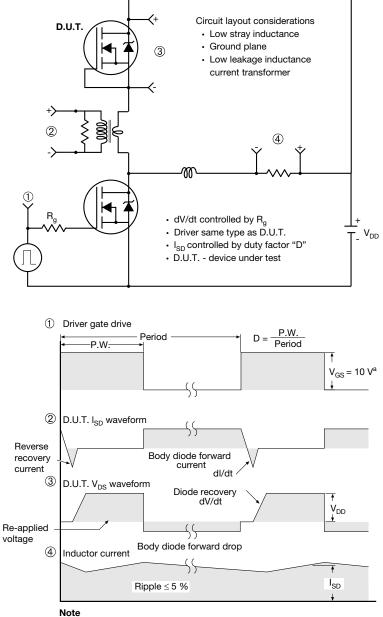
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#### Peak Diode Recovery dV/dt Test Circuit



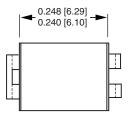
a.  $V_{GS} = 5 V$  for logic level devices

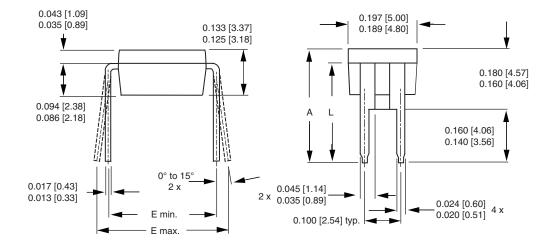
Fig. 17 - For N-Channel

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### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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